

SLOVENSKI STANDARD

SIST EN 61158-2:2010

01-december-2010

Nadomešča:

SIST EN 61158-2:2008

Industrijska komunikacijska omrežja - Specifikacije za procesna vodila - 2. del: Specifikacija fizičnega nivoja in definicija opravil (IEC 61158-2:2010)

Industrial communication networks - Fieldbus specifications - Part 2: Physical layer specification and service definition (IEC 61158-2:2010)

Réseaux de communication industriels - Spécifications des bus de terrain - Partie 2: Spécification des couches physiques et définition des services (IEC 61158-2:2010)

Réseaux de communication industriels - Spécifications des bus de terrain - Partie 2: Spécification des couches physiques et définition des services (CEI 61158-2:2010)

Ta slovenski standard je istoveten z: EN 61158-2:2010

ICS:

25.040.40	Merjenje in krmiljenje industrijskih postopkov	Industrial process measurement and control
35.100.10	Fizični sloj	Physical layer
35.110	Omreževanje	Networking

SIST EN 61158-2:2010

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EUROPEAN STANDARD
NORME EUROPÉENNE
EUROPÄISCHE NORM

EN 61158-2

October 2010

ICS 25.040; 35.100; 35.240.50

Supersedes EN 61158-2:2008

English version

**Industrial communication networks -
Fieldbus specifications -
Part 2: Physical layer specification and service definition
(IEC 61158-2:2010)**

Réseaux de communication industriels -
Spécifications des bus de terrain -
Partie 2: Spécification des couches
physiques et définition des services
(CEI 61158-2:2010)

Industrielle Kommunikationsnetze -
Feldbusse -
Teil 2: Spezifikation
und Dienstfestlegungen des Physical
Layer (Bitübertragungsschicht)
(IEC 61158-2:2010)

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This European Standard was approved by CENELEC on 2010-09-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

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CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Management Centre: Avenue Marnix 17, B - 1000 Brussels

Foreword

The text of document 65C/598/FDIS, future edition 5 of IEC 61158-2, prepared by SC 65C, Industrial networks, of IEC TC 65, Industrial-process measurement, control and automation, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 61158-2 on 2010-09-01.

This European Standard supersedes EN 61158-2:2008.

This EN 61158-2:2010 includes the following significant technical changes with respect to EN 61158-2:2008:

- for Type 18, Table 157 reduced tolerance to 5 %;
- for Type 18, in 32.5.3.1 removed minimum cable length;
- for Type 18, in 32.5.4. and R.2.2 cable reference removed;
- for Type 18, Table 160 and 161 terminating resistor value changed to 680 Ω .

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN and CENELEC shall not be held responsible for identifying any or all such patent rights.

The following dates were fixed:

- latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2011-06-01
- latest date by which the national standards conflicting with the EN have to be withdrawn (dow) 2013-09-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 61158-2:2010 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60079-0	NOTE Harmonized as EN 60079-0.
IEC 60079-27	NOTE Harmonized as EN 60079-27.
IEC 60875-1	NOTE Harmonized as EN 60875-1.
IEC 60947-5-2	NOTE Harmonized as EN 60947-5-2.
IEC/TR 61158-1	NOTE Harmonized as CLC/TR 61158-1.
IEC 61158-4-1:2007	NOTE Harmonized as EN 61158-4-1:2008 (not modified).
IEC 61158-4-4:2007	NOTE Harmonized as EN 61158-4-4:2008 (not modified).
IEC 61158-4-7:2007	NOTE Harmonized as EN 61158-4-7:2008 (not modified).
IEC 61158-4-8:2007	NOTE Harmonized as EN 61158-4-8:2008 (not modified).
IEC 61158-4-16:2007	NOTE Harmonized as EN 61158-4-16:2008 (not modified).
IEC 61300-3-4	NOTE Harmonized as EN 61300-3-4.

IEC 61491	NOTE Harmonized as EN 61491.
IEC 61596	NOTE Harmonized as EN 61596.
IEC 61784-1	NOTE Harmonized as EN 61784-1.

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Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

Publication	Year	Title	EN/HD	Year
IEC 60050-731	-	International Electrotechnical Vocabulary (IEV) - Chapter 731: Optical fibre communication	-	-
IEC 60079-11	-	Explosive atmospheres - Part 11: Equipment protection by intrinsic safety "i"	EN 60079-11	-
IEC 60079-14	2002	Electrical apparatus for explosive gas atmospheres - Part 14: Electrical installations in hazardous areas (other than mines)	EN 60079-14 ¹⁾	2003
IEC 60079-25	-	Explosive atmospheres - Part 25: Intrinsically safe electrical systems	EN 60079-25	-
IEC 60169-17	1980	Radio-frequency connectors - Part 17: R.F. coaxial connectors with inner diameter of outer conductor 6,5mm (0,256 in) with screw coupling - Characteristic impedance 50 ohms (type TNC)	-	-
IEC 60189-1	2007	Low-frequency cables and wires with PVC insulation and PVC sheath - Part 1: General test and measuring methods	-	-
IEC 60255-22-1 (mod)	1988	Electrical relays - Part 22: Electrical disturbance tests for measuring relays and protection equipment - Section 1: 1 MHz burst disturbance tests	-	-
IEC 60364-4-41 (mod)	-	Low-voltage electrical installations - Part 4-41: Protection for safety - Protection against electric shock	HD 60364-4-41	-
IEC 60364-5-54 (mod)	-	Electrical installations of buildings - Part 5-54: Selection and erection of electrical equipment - Earthing arrangements, protective conductors and protective bonding conductors	HD 60364-5-54	-
IEC 60529	-	Degrees of protection provided by enclosures - (IP Code)	-	-

¹⁾ EN 60079-14 is superseded by EN 60079-14:2008, which is based on IEC 60079-14:2007.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60603-7-4	-	Connectors for electronic equipment - Part 7-4: Detail specification for 8-way, unshielded, free and fixed connectors, for data transmissions with frequencies up to 250 MHz	EN 60603-7-4	-
IEC 60760	-	Flat, quick-connect terminations	-	-
IEC 60793	Series	Optical fibres	-	-
IEC 60794-1-2	2003	Optical fibre cables - Part 1-2: Generic specification - Basic optical cable test procedures	EN 60794-1-2	2003
IEC 60807-3	-	Rectangular connectors for frequencies below - 3 MHz - Part 3: Detail specification for a range of connectors with trapezoidal shaped metal shells and round contacts - Removable crimp types with closed crimp barrels, rear insertion/rear extraction	-	-
IEC 60874-10-1	-	Connectors for optical fibres and cables - Part 10-1: Detail specification for fibre optic connector type BFOC/2,5 terminated to multimode fibre type A1	-	-
IEC 61000-4-2	-	Electromagnetic compatibility (EMC) - Part 4-2: Testing and measurement techniques - Electrostatic discharge immunity test	EN 61000-4-2	-
IEC 61000-4-3	-	Electromagnetic compatibility (EMC) - Part 4-3: Testing and measurement techniques - Radiated, radio-frequency, electromagnetic field immunity test	EN 61000-4-3	-
IEC 61000-4-4	-	Electromagnetic compatibility (EMC) - Part 4-4: Testing and measurement techniques - Electrical fast transient/burst immunity test	EN 61000-4-4	-
IEC 61131-2	-	Programmable controllers - Part 2: Equipment requirements and tests	EN 61131-2	-
IEC 61156-1	2007	Multicore and symmetrical pair/quad cables for digital communications - Part 1: Generic specification	-	-
IEC 61158-4-2	-	Industrial communication networks - Fieldbus specifications - Part 4-2: Data-link layer protocol specification - Type 2 elements	EN 61158-4-2	-
IEC 61158-4-3	2010	Industrial communication networks - Fieldbus specifications - Part 4-3: Data-link layer protocol specification - Type 3 elements	-	-
IEC 61169-8	2007	Radio-frequency connectors - Part 8: Sectional specification - RF coaxial connectors with inner diameter of outer conductor 6,5 mm (0,256 in) with bayonet lock - Characteristics impedance 50 ohms (type BNC)	EN 61169-8	2007
IEC 61754-2	-	Fibre optic connector interfaces - Part 2: Type BFOC/2,5 connector family	EN 61754-2	-

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61754-13	-	Fibre optic connector interfaces - Part 13: Type FC-PC connector	EN 61754-13	-
IEC 61754-22	-	Fibre optic connector interfaces - Part 22: Type F-SMA connector family	EN 61754-22	-
ISO/IEC 7498	Series	Information technology - Open Systems Interconnection - Basic Reference Model: The Basic Model	-	-
ISO/IEC 8482	-	Information technology - Telecommunications and information exchange between systems - Twisted pair multipoint interconnections	-	-
ISO/IEC 8802-3	-	Information technology - Telecommunications - and information exchange between systems - Local and metropolitan area networks - Specific requirements - Part 3: Carrier sense multiple access with collision detection (CSMA/CD) access method and physical layer specifications	-	-
ISO/IEC 9314-1	-	Information Processing Systems - Fibre distributed data interface (FDDI) - Part 1: Token Ring physical layer protocol (PHY)	-	-
ISO/IEC 10731	-	Information technology - Open Systems Interconnection - Basic reference model - Conventions for the definition of OSI services	-	-
ANSI TIA/EIA-232-F	-	Interface between data terminal equipment and data circuit-terminating equipment employing serial binary data interchange	-	-
ANSI TIA/EIA-422-B	-	Electrical characteristics of balanced voltage digital interface circuits	-	-
ANSI TIA/EIA-485-A	-	Electrical Characteristics of Generators and Receivers for Use in Balanced Digital Multipoint Systems	-	-
ANSI TIA/EIA-644-A	-	Electrical Characteristics of Low Voltage Differential Signaling (LVDS) Interface Circuits	-	-



IEC 61158-2

Edition 5.0 2010-07

INTERNATIONAL STANDARD

**Industrial communication networks – Fieldbus specifications –
Part 2: Physical layer specification and service definition**

SIST EN 61158-2:2010
<https://standards.iteh.ai/catalog/standards/sist/4cec29d1-22e8-46b7-a5f6-90ea976d4106/sist-en-61158-2-2010>

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

PRICE CODE **XN**

ICS, 25.040, 35.100, 35.240.50

ISBN 978-2-88912-051-2

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